

SURFACE MOUNT SCHOTTKY BARRIER DIODE ARRAYS

Product Summary (@TA = +25°C)

| V _{RRM} (V) | I _F (mA) | V _{F(MAX)} (V) | I _{R(MAX)} (μA) |
|----------------------|---------------------|-------------------------|--------------------------|
| 30 | 200 | 1 | 2.0 |

Features and Benefits

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Description

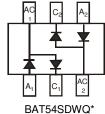
200mA surface mount Schottky Barrier Diode in SOT363 package, offers low turn-on voltage and fast switching capability, designed with PN Junction Guard Ring for Transient and ESD Protection, totally lead-free finish and RoHS compliant, "Green" device.

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe). Solderable per MIL-STD-202, Method 208(63)
- Weight: 0.006 grams (Approximate)



Top View



*Symmetrical configuration, no orientation indicator.

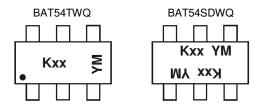
Ordering Information (Note 5)

| Part Number | Application | Packaging | | |
|---------------|-------------|-----------|-------------------|--|
| BAT54SDWQ-7-F | Automotive | SOT363 | 3,000/Tape & Reel | |
| BAT54TWQ-7-F | Automotive | SOT363 | 3,000/Tape & Reel | |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



Kxx = Product Type Marking Code

For Symmetrical Configuration, No Orientation Indicator

KL8 = BAT54SDWQ KLA = BAT54TWQ

YM = Date Code Marking Y = Year (ex: F = 2018)

M = Month (ex: 9 = September)

Date Code Key

| Year | 2001 | 2002 | | 2011 | 2012 | 2013 | 2014 | 2015 | 2016 | 2017 | 2018 | 2019 | 2020 | 2021 | 2022 |
|-------|------|------|-----|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | М | N | | Υ | Z | Α | В | С | D | Е | F | G | Н | 1 | J |
| Month | Jan | Feb |) [| Mar | Apr | May | Jur | 1 | Jul | Aug | Sep | Oc | t N | Nov | Dec |
| Code | 1 | 2 | | 3 | 4 | 5 | 6 | | 7 | 8 | 9 | 0 | | N | D |



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--|--|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 30 | ٧ |
| Forward Continuous Current (Note 6) | l _F | 200 | mA |
| Repetitive Peak Forward Current (Note 6) | I _{FRM} | 300 | mA |
| Forward Surge Current (Note 6) @ t < 1.0s | I _{FSM} | 600 | mA |

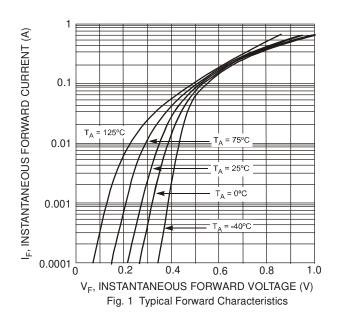
Thermal Characteristics

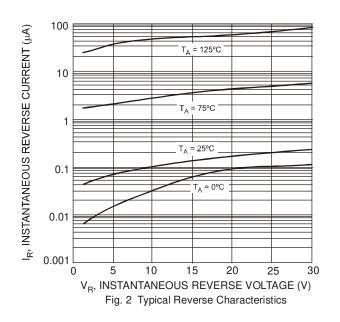
| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 6) | P_{D} | 200 | mW |
| Thermal Resistance, Junction to Ambient Air (Note 6) | $R_{	hetaJA}$ | 625 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +125 | °C |

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|-----------------|-----|-----|-----------------------------------|------|--|
| Reverse Breakdown Voltage (Note 7) | $V_{(BR)R}$ | 30 | _ | _ | V | $I_R = 100 \mu A$ |
| Forward Voltage (Note 7) | V _F | _ | _ | 240 320 400 500 1,000 | mV | I _F = 0.1mA I _F = 1mA I _F = 10mA I _F = 30mA I _F = 100mA |
| Reverse Leakage Current (Note 7) | I _R | _ | _ | 2.0 | μΑ | V _R = 25V |
| Total Capacitance | Ст | _ | _ | 10 | pF | V _R = 1.0V, f = 1.0MHz |
| Reverse Recovery Time | t _{RR} | _ | _ | 5.0 | ns | $I_F = 10 mA$ through $I_R = 10 mA$ to $I_R = 1.0 mA$, $R_L = 100 \Omega$ |

Notes:

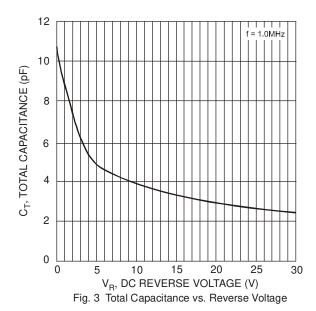
- 6. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 7. Short duration pulse test used to minimize self-heating effect.

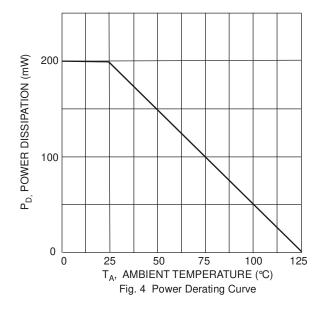










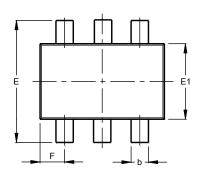


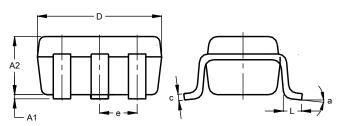


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



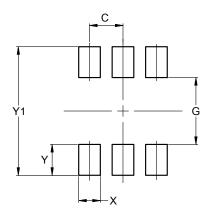


| | SOT363 | | | | | | | |
|------------|----------------------|---------|-------|--|--|--|--|--|
| Dim | Min | Max | Тур | | | | | |
| A 1 | 0.00 | 0.10 | 0.05 | | | | | |
| A2 | 0.90 | 1.00 | 0.95 | | | | | |
| b | 0.10 | 0.30 | 0.25 | | | | | |
| С | 0.10 | 0.22 | 0.11 | | | | | |
| D | 1.80 | 2.20 | 2.15 | | | | | |
| Е | 2.00 | 2.20 | 2.10 | | | | | |
| E1 | 1.15 | 1.35 | 1.30 | | | | | |
| е | C |).650 E | SC | | | | | |
| F | 0.40 | 0.45 | 0.425 | | | | | |
| L | 0.25 | 0.40 | 0.30 | | | | | |
| а | 0° | 8° | | | | | | |
| All I | All Dimensions in mm | | | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



| Dimensions | Value (in mm) |
|------------|------------------|
| С | 0.650 |
| G | 1.300 |
| Х | 0.420 |
| Y | 0.600 |
| Y1 | 2.500 |



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